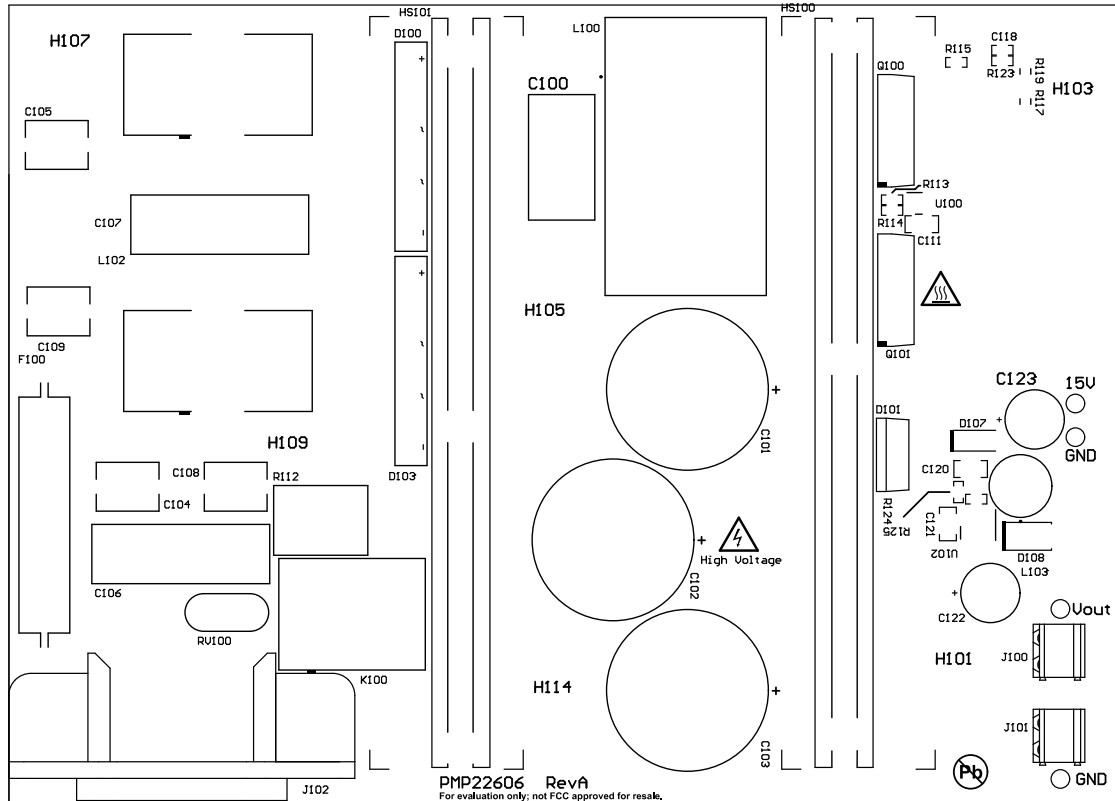
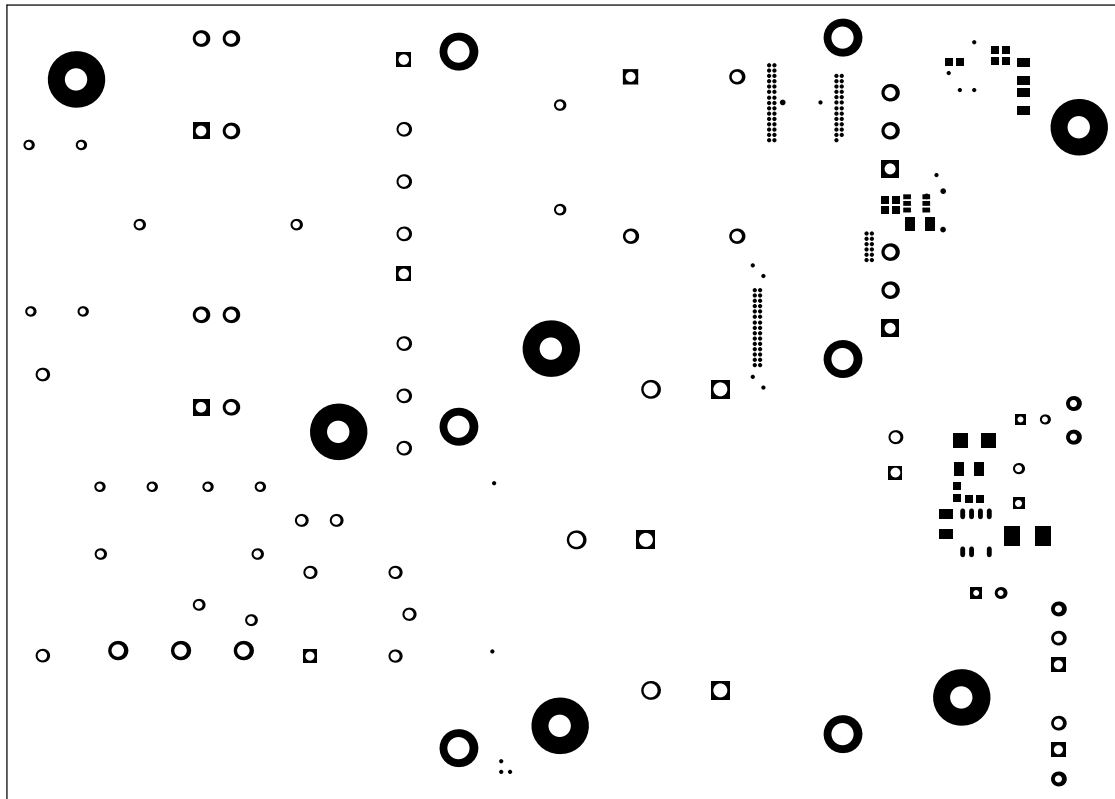


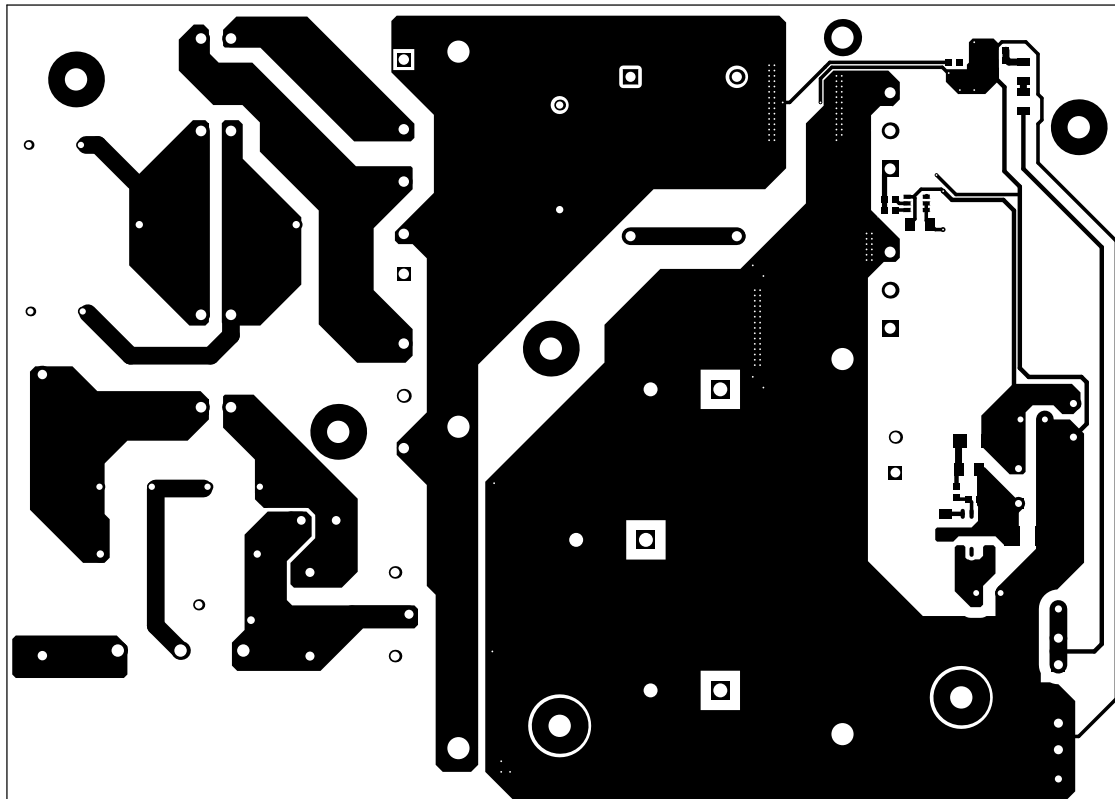
L101



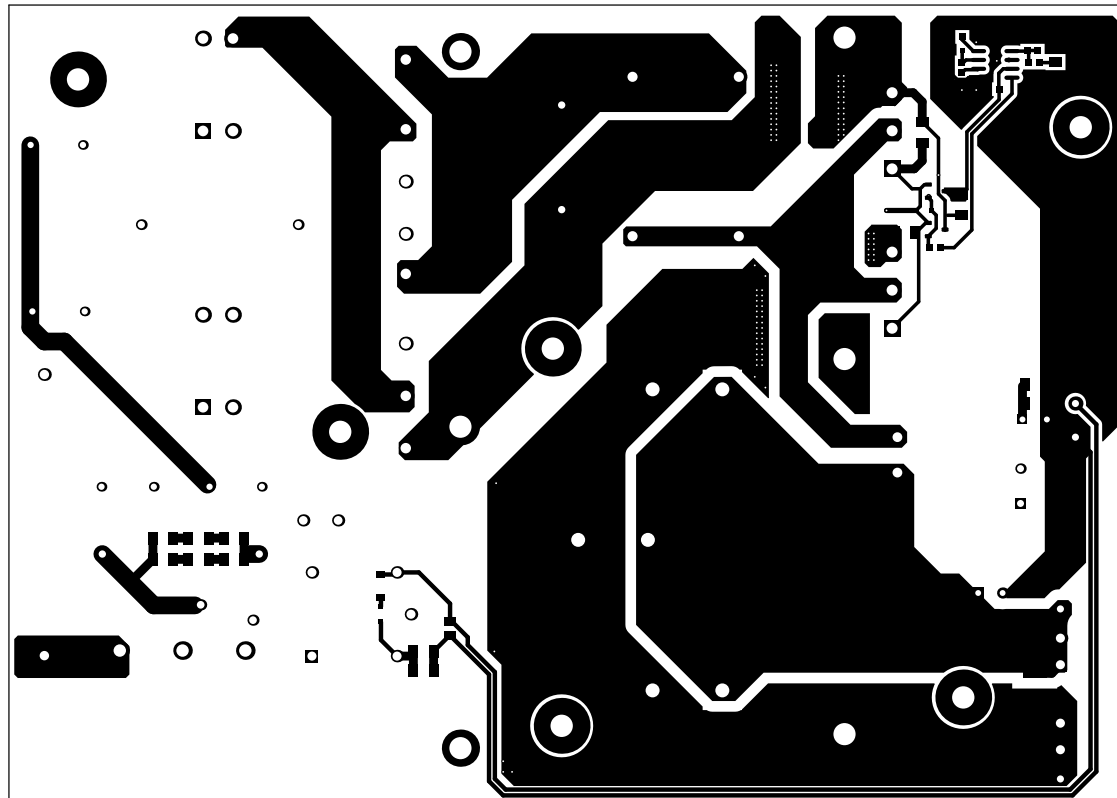
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP22606	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 10/18/2020 4:44:23 PM	TEXAS INSTRUMENTS	



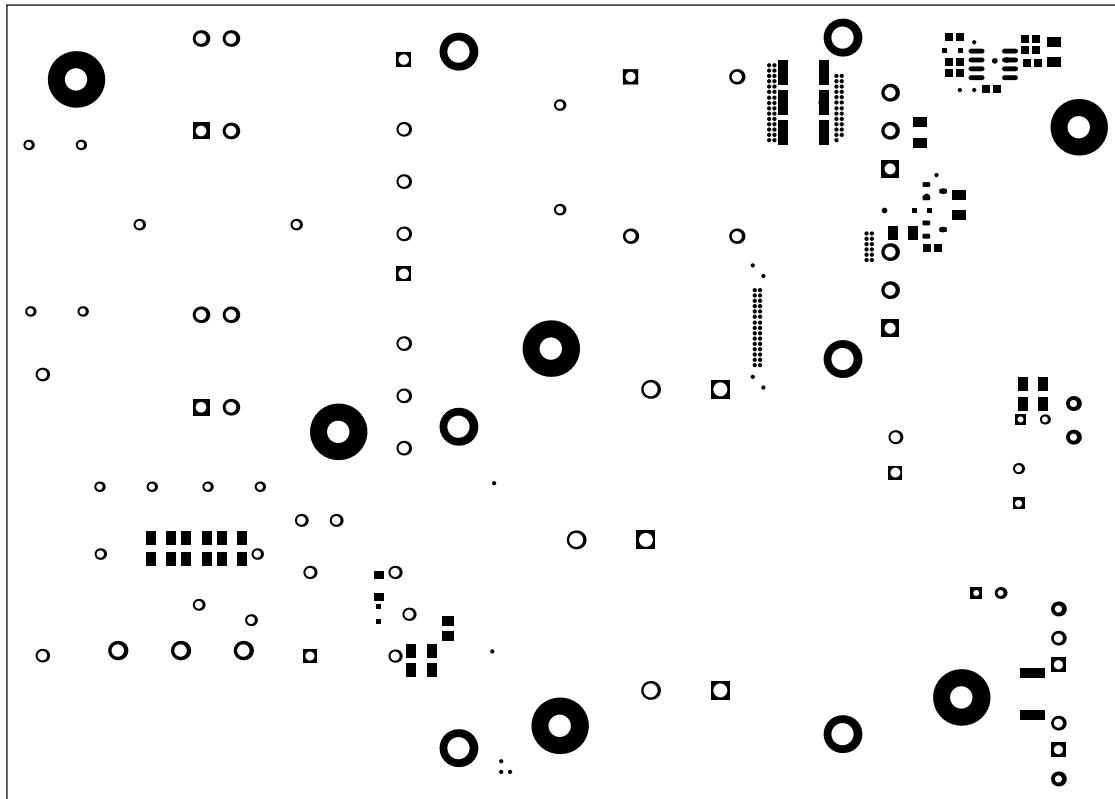
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP22606	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 10/18/2020 4:44:25 PM	TEXAS INSTRUMENTS	



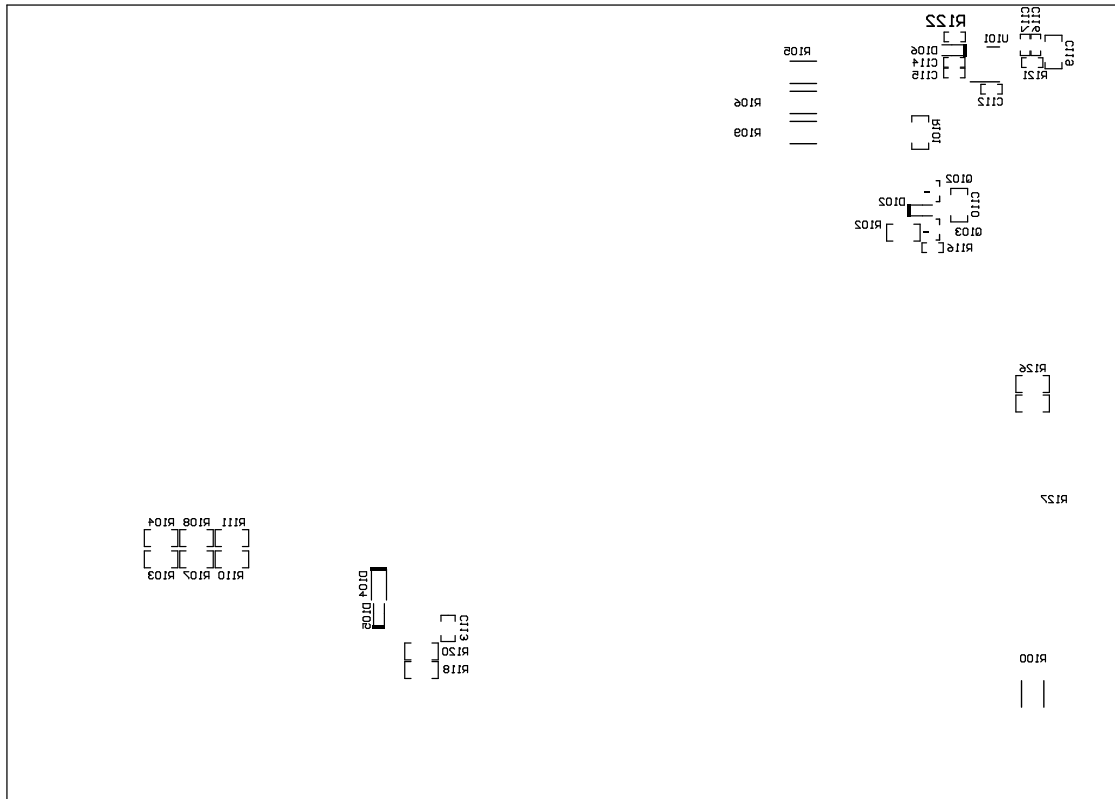
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP22606	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 10/18/2020 4:44:27 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP22606	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 10/18/2020 4:44:28 PM	TEXAS INSTRUMENTS	

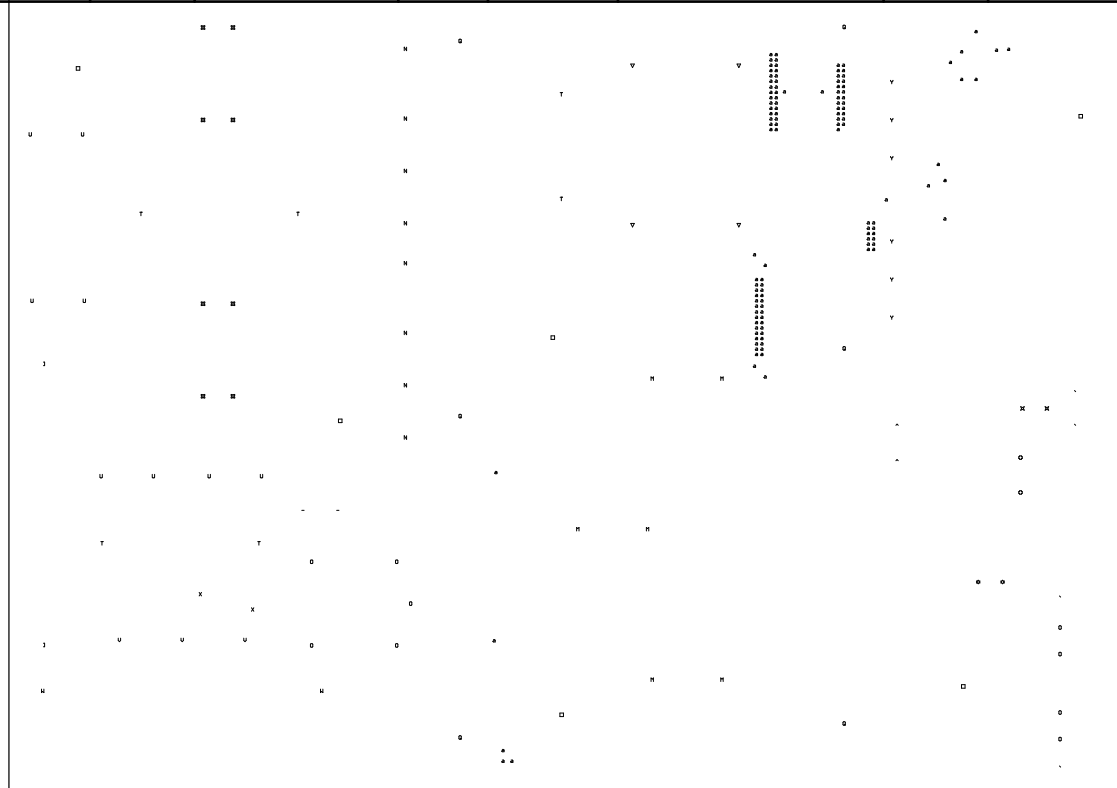


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP22606	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 10/18/2020 4:44:30 PM	TEXAS INSTRUMENTS	

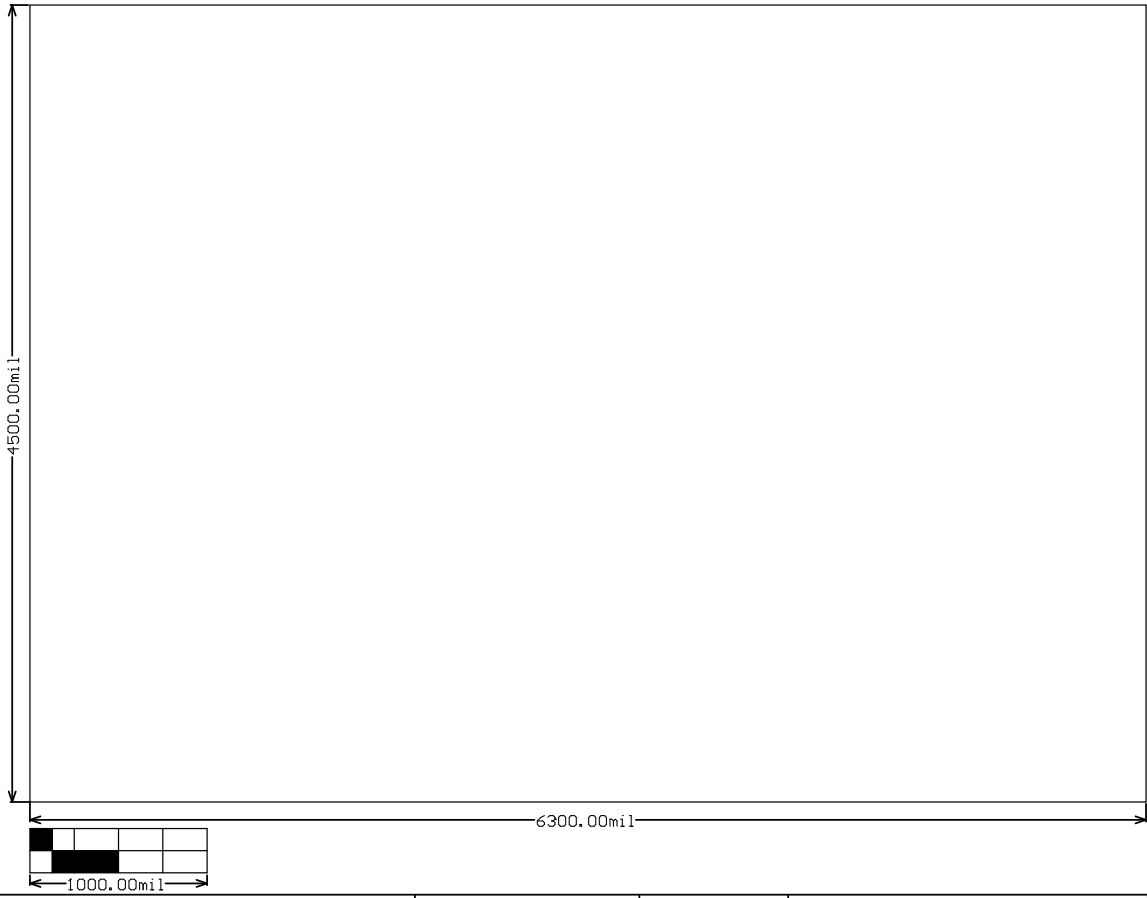


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP22606	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 10/18/2020 4:44:31 PM	TEXAS INSTRUMENTS	

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape	Template	Description	Hole Tolerance (+)	Hole Tolerance (-)
☆	2	33.00mil (0.838mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
⊗	2	33.47mil (0.850mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
⊕	2	39.37mil (1.000mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
X	2	43.31mil (1.100mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c160h110			
-	2	49.21mil (1.250mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c175h125			
J	2	53.15mil (1.350mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c185h135			
^	2	55.12mil (1.400mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
W	2	137.79mil (3.500mm)	NPTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c100hn350			
U	3	70.00mil (1.778mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c267h178			
\	4	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c203h102			
▽	4	57.09mil (1.450mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
T	6	41.34mil (1.050mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c155h105			
Y	6	62.00mil (1.575mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
M	6	78.74mil (2.000mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
Q	6	125.00mil (3.175mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c533h318			
□	6	125.98mil (3.200mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c800h320			
U	8	35.43mil (0.900mm)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c140h90			
N	8	59.06mil (1.500mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
⊗	8	60.00mil (1.524mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
O	9	51.18mil (1.300mm)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
a	120	10.00mil (0.254mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	<Mixed>			
	210 Total										



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP22606	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 10/18/2020 4:44:33 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP22606	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 10/18/2020 4:44:35 PM	TEXAS INSTRUMENTS	

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